



US00D806685S

(12) **United States Design Patent**
Park

(10) **Patent No.:** **US D806,685 S**
(45) **Date of Patent:** **** Jan. 2, 2018**

(54) **HEADPHONE**

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(**) Term: **15 Years**

(21) Appl. No.: **29/576,075**

(22) Filed: **Aug. 31, 2016**

(51) **LOC (11) Cl.** **14-01**

(52) **U.S. Cl.**
USPC **D14/223**

(58) **Field of Classification Search**
USPC D14/223, 205, 206; 181/129, 130, 135;
379/430, 431; 381/380, 381, 370, 322,
381/325, 326, 328; 455/90.3, 575.1,
455/569.1; D24/174
CPC H04R 1/10; H04R 25/00; H04R 1/1041;
H04R 1/1058; H04R 1/1091; H04R
5/033; H04R 5/0335; H04R 1/1016;
H04R 1/1066

See application file for complete search history.

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(57) **CLAIM**

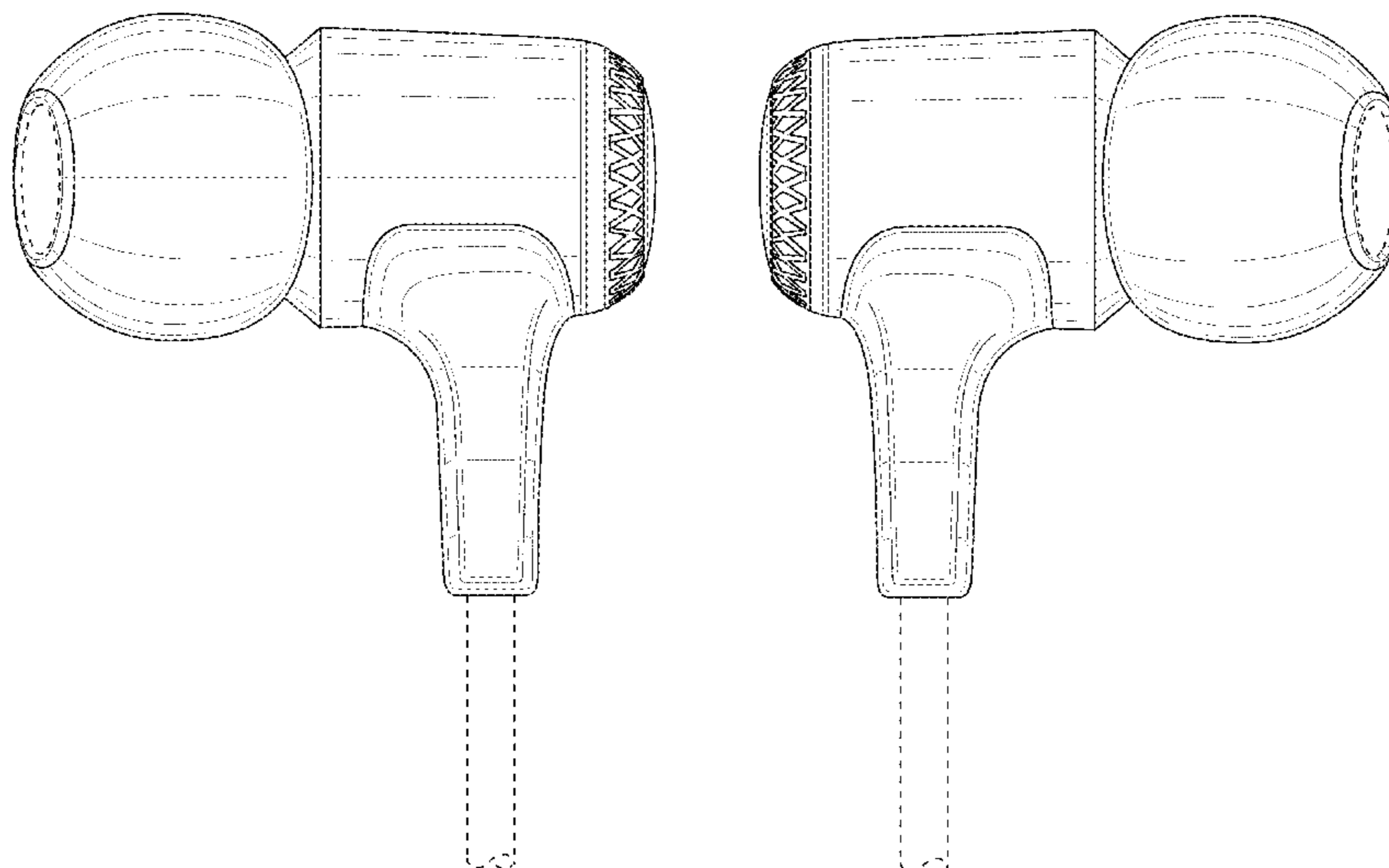
The ornamental design for a headphone, as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of a headphone showing the new design;
 FIG. 2 is another perspective view thereof;
 FIG. 3 is a front elevation view thereof;
 FIG. 4 is a rear elevation view thereof;
 FIG. 5 is a side elevation view of one side thereof;
 FIG. 6 is a side elevation view of the opposite side thereof;
 FIG. 7 is a top plan view thereof;
 FIG. 8 is a bottom plan view thereof;
 FIG. 9 is a perspective view of an opposite-handed embodiment of the headphone showing the new design;
 FIG. 10 is another perspective view thereof;
 FIG. 11 is a front elevation view thereof;
 FIG. 12 is a rear elevation view thereof;
 FIG. 13 is a side elevation view of one side thereof;
 FIG. 14 is a side elevation view of the opposite side thereof;
 FIG. 15 is a top plan view thereof; and,
 FIG. 16 is bottom plan view thereof.

The broken lines and unshaded areas form no part of the claimed design.

1 Claim, 16 Drawing Sheets



(56)

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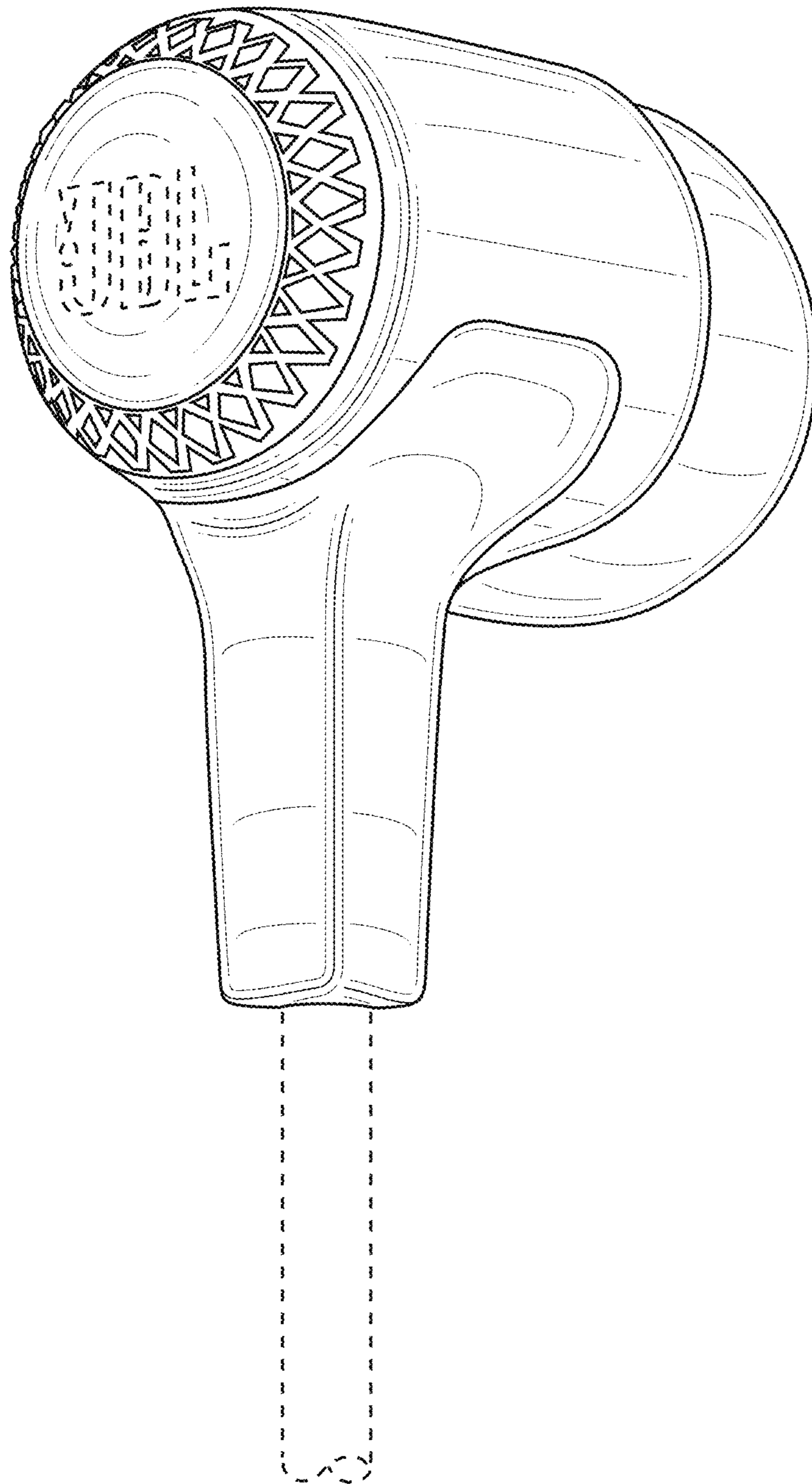


FIG. 1

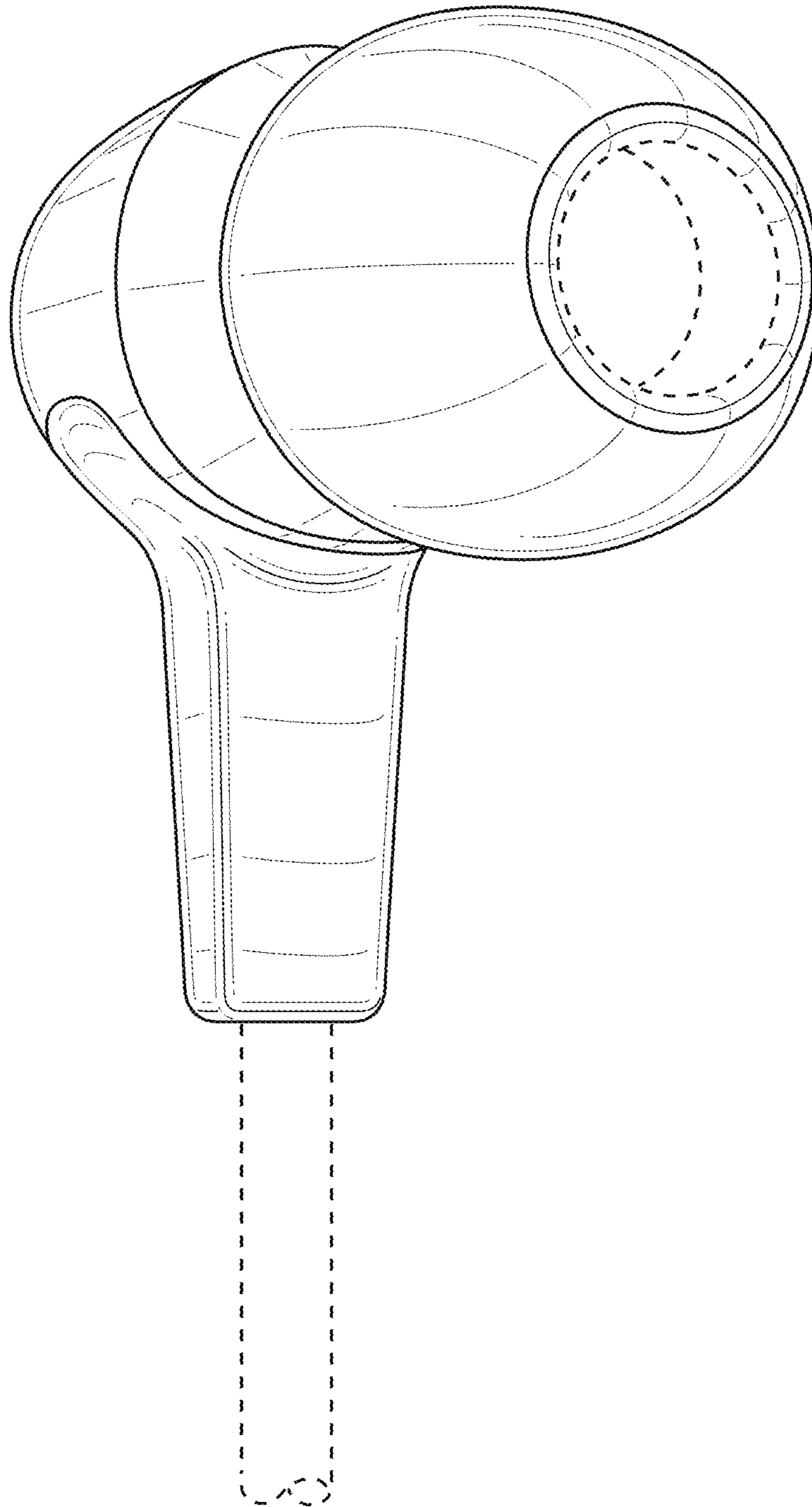


FIG. 2

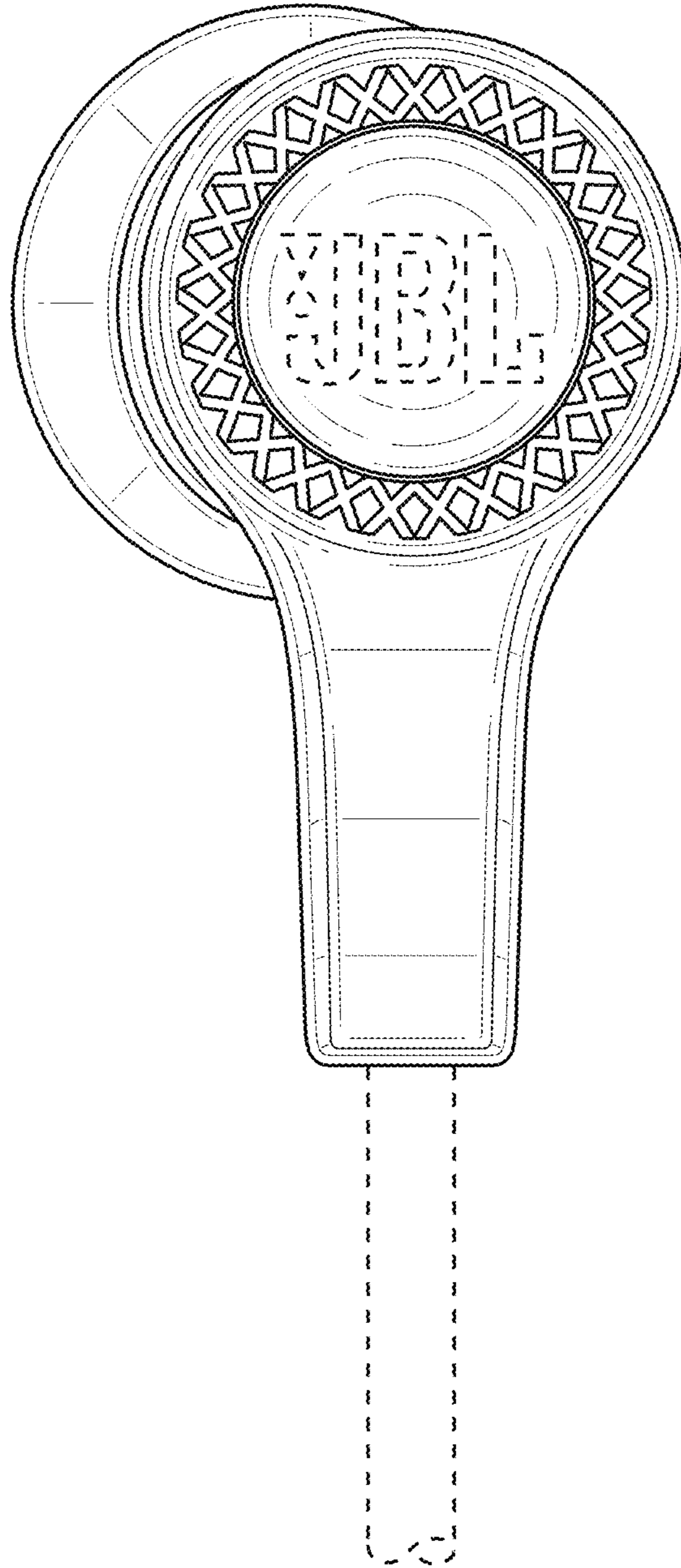


FIG. 3

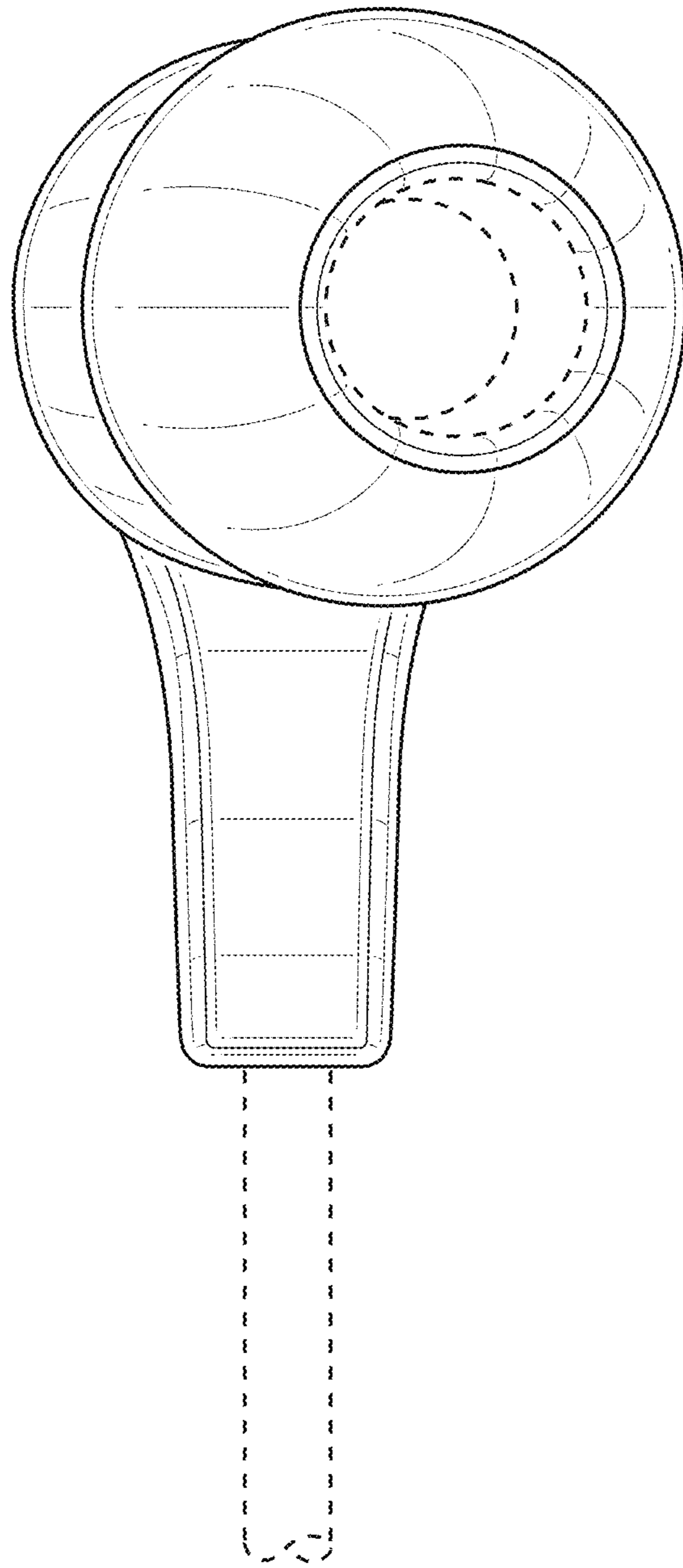


FIG. 4

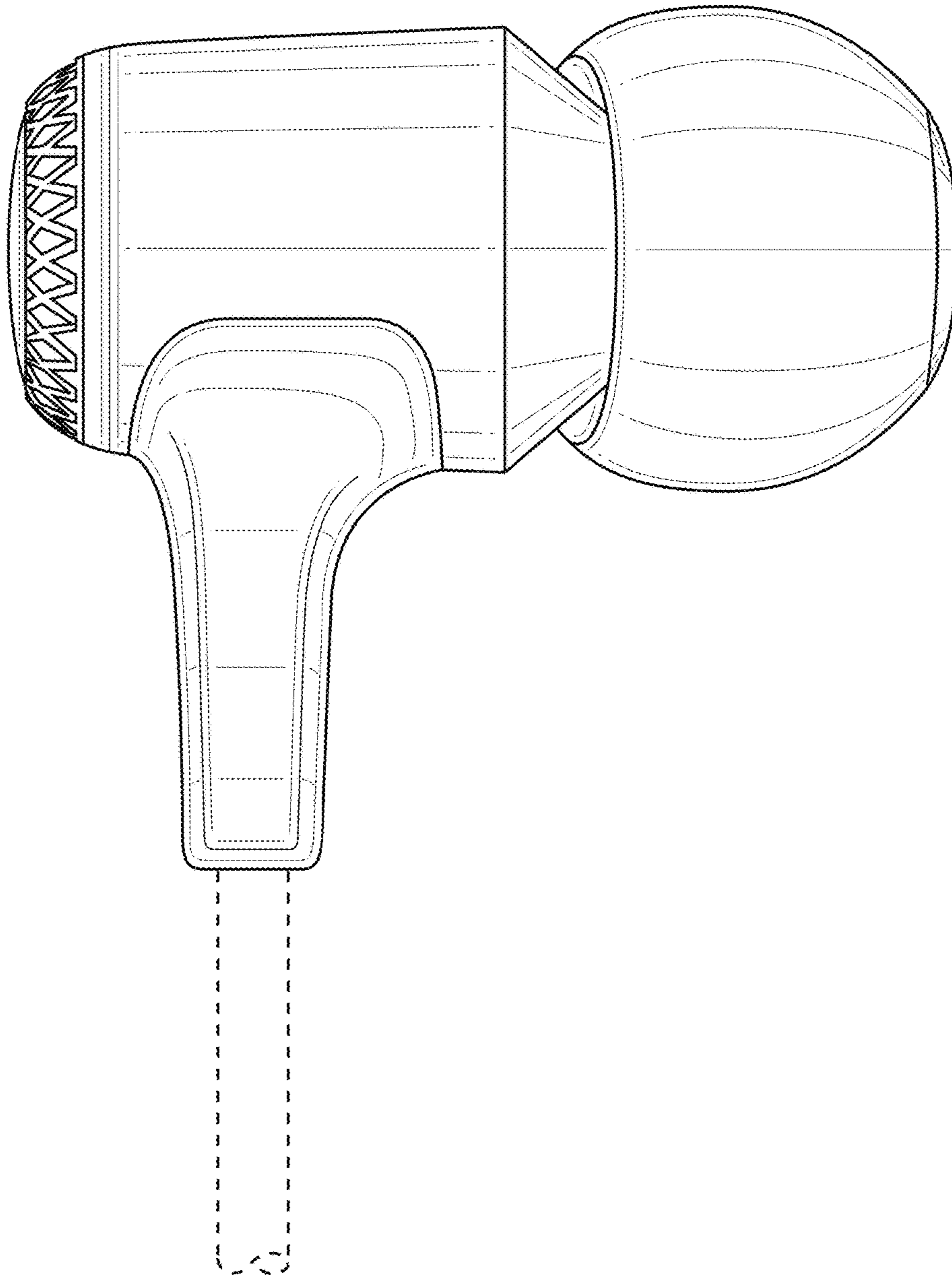


FIG. 5

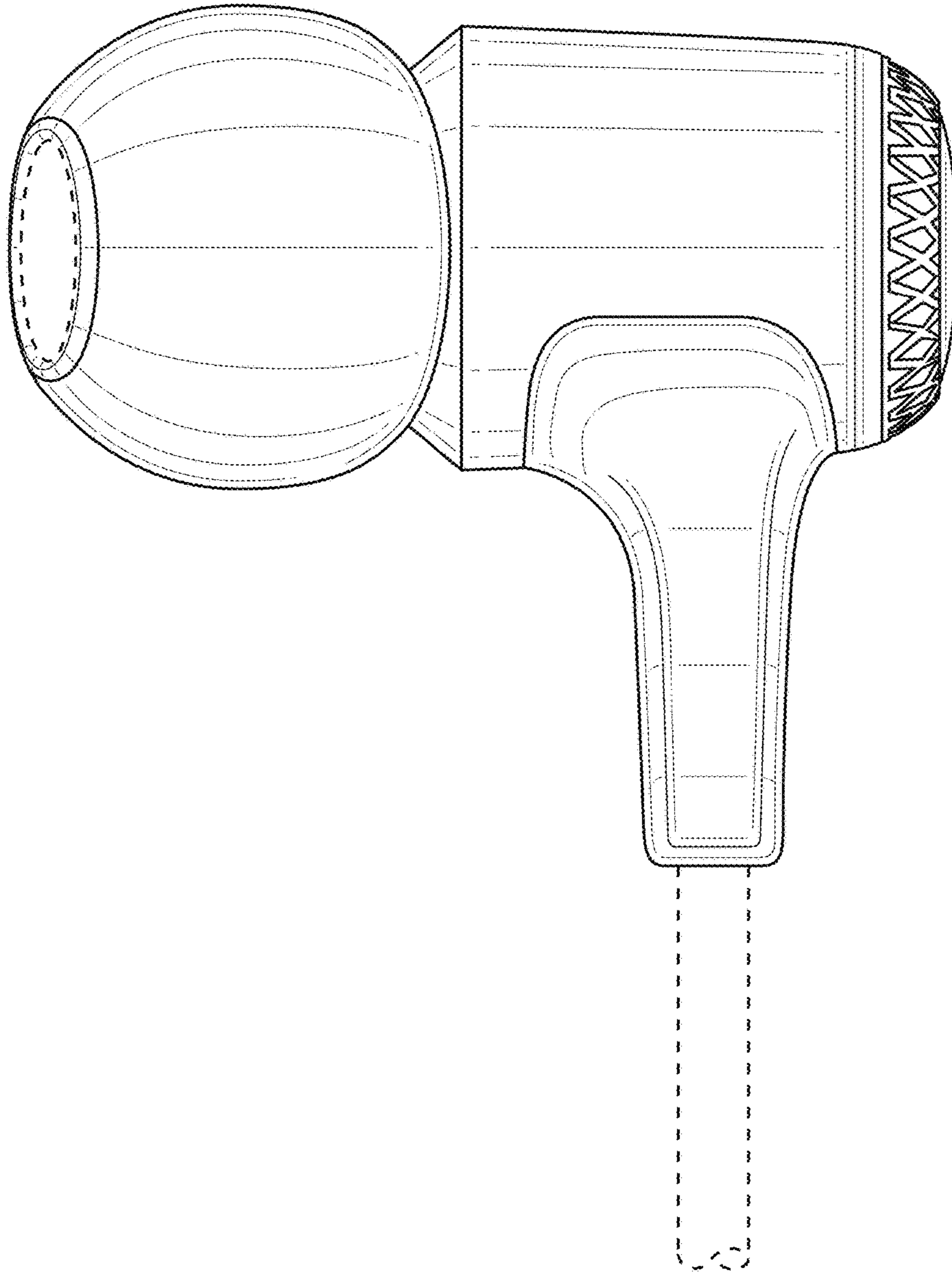


FIG. 6

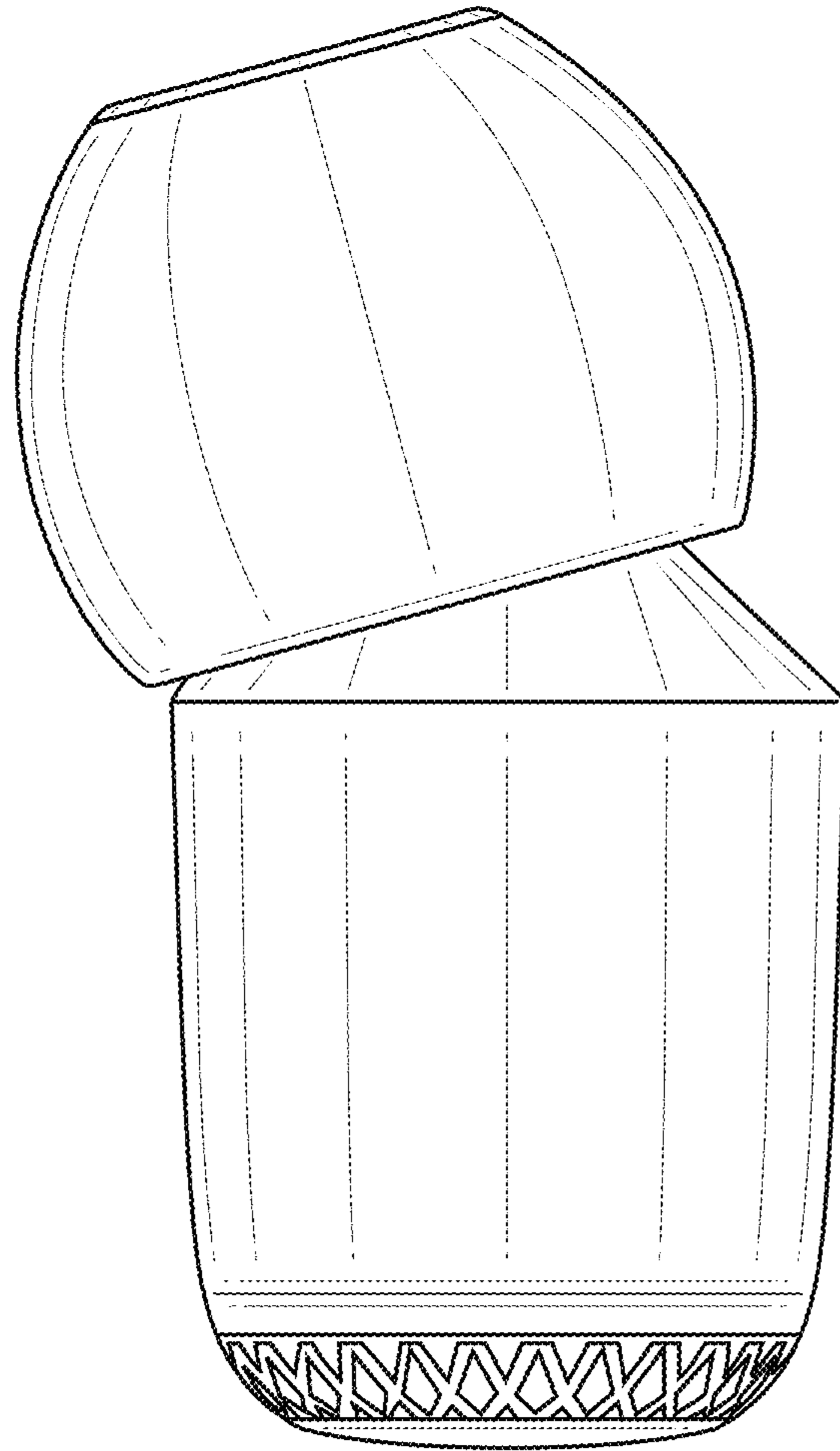


FIG. 7

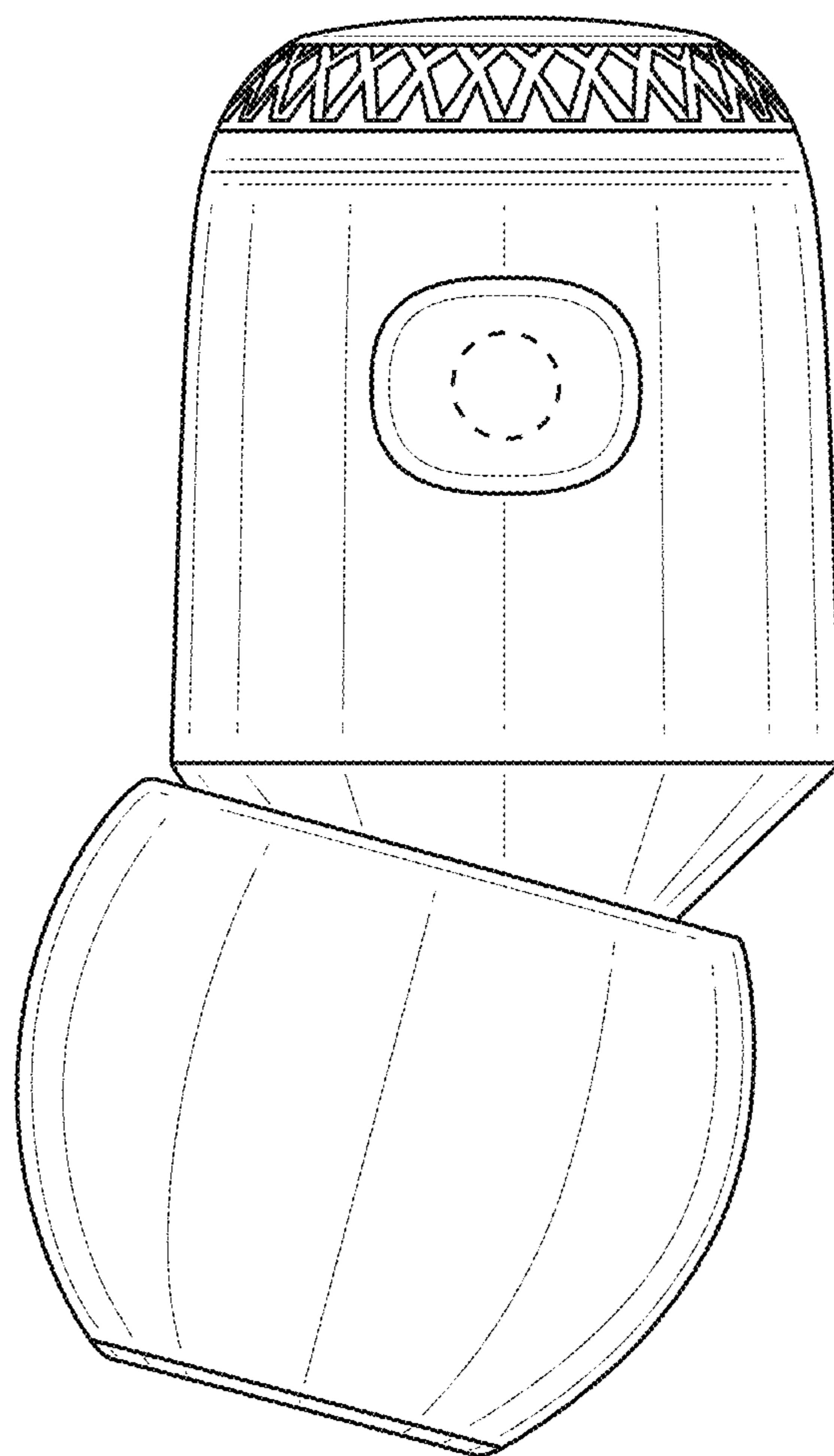


FIG. 8

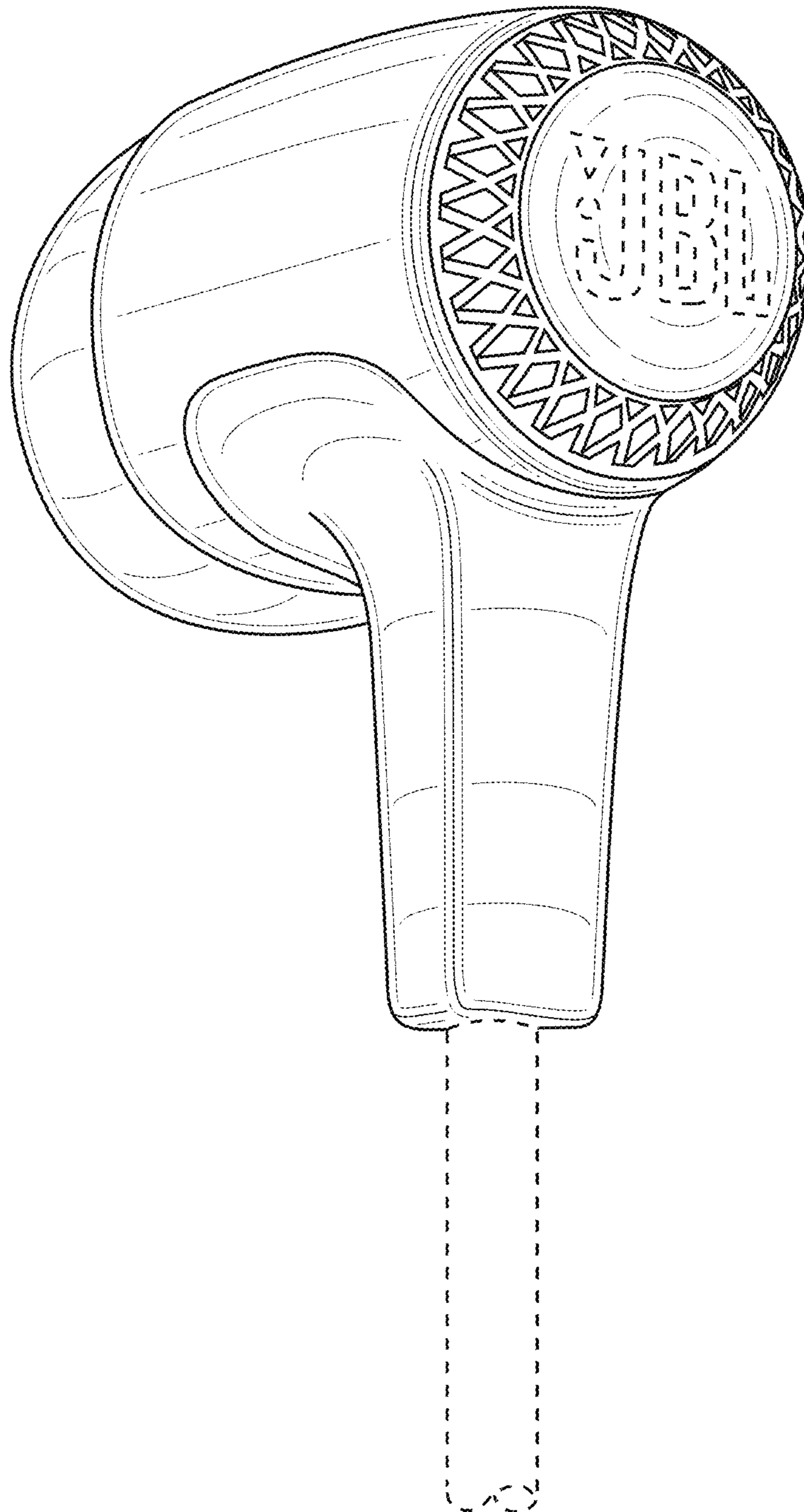


FIG. 9

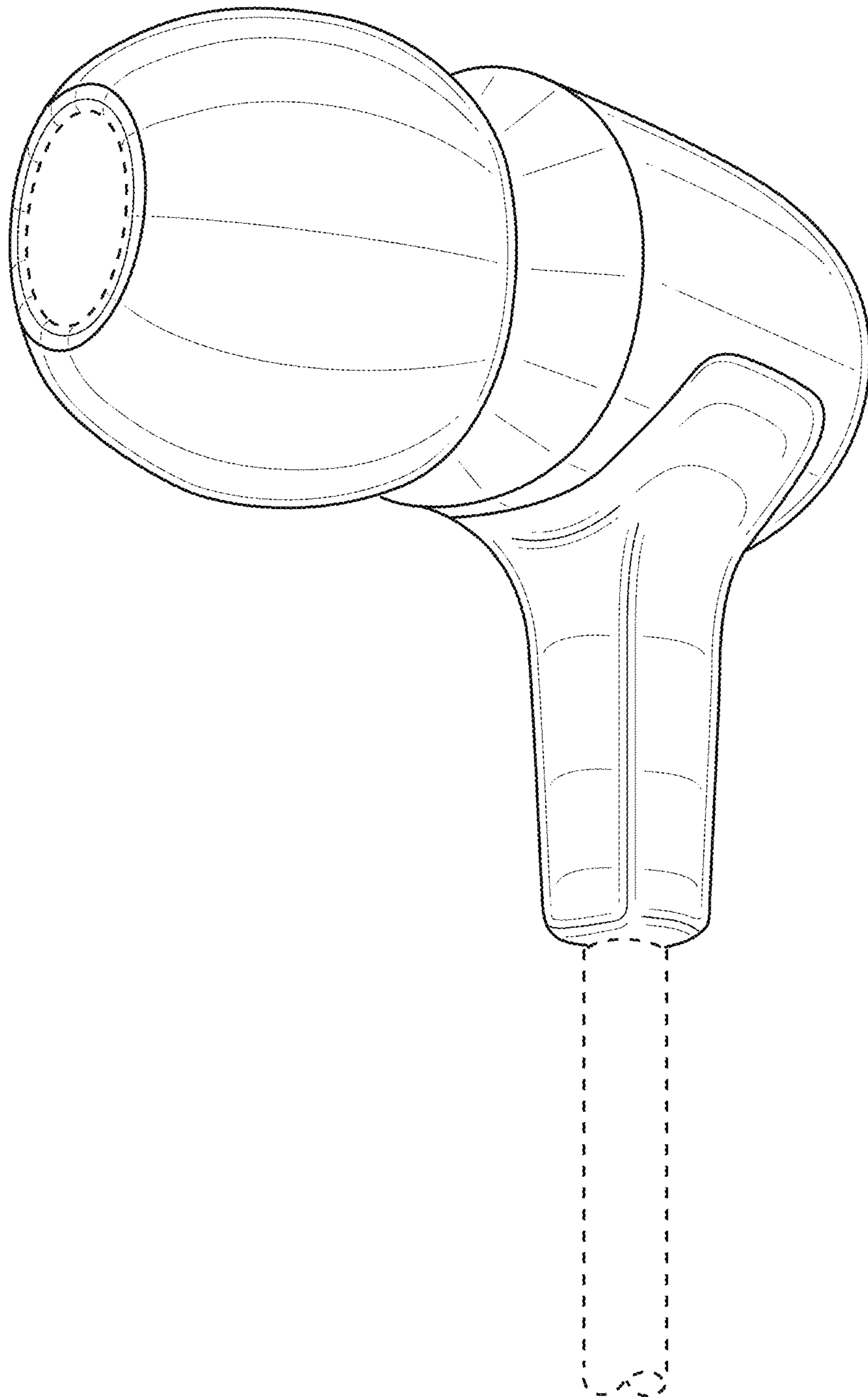


FIG. 10

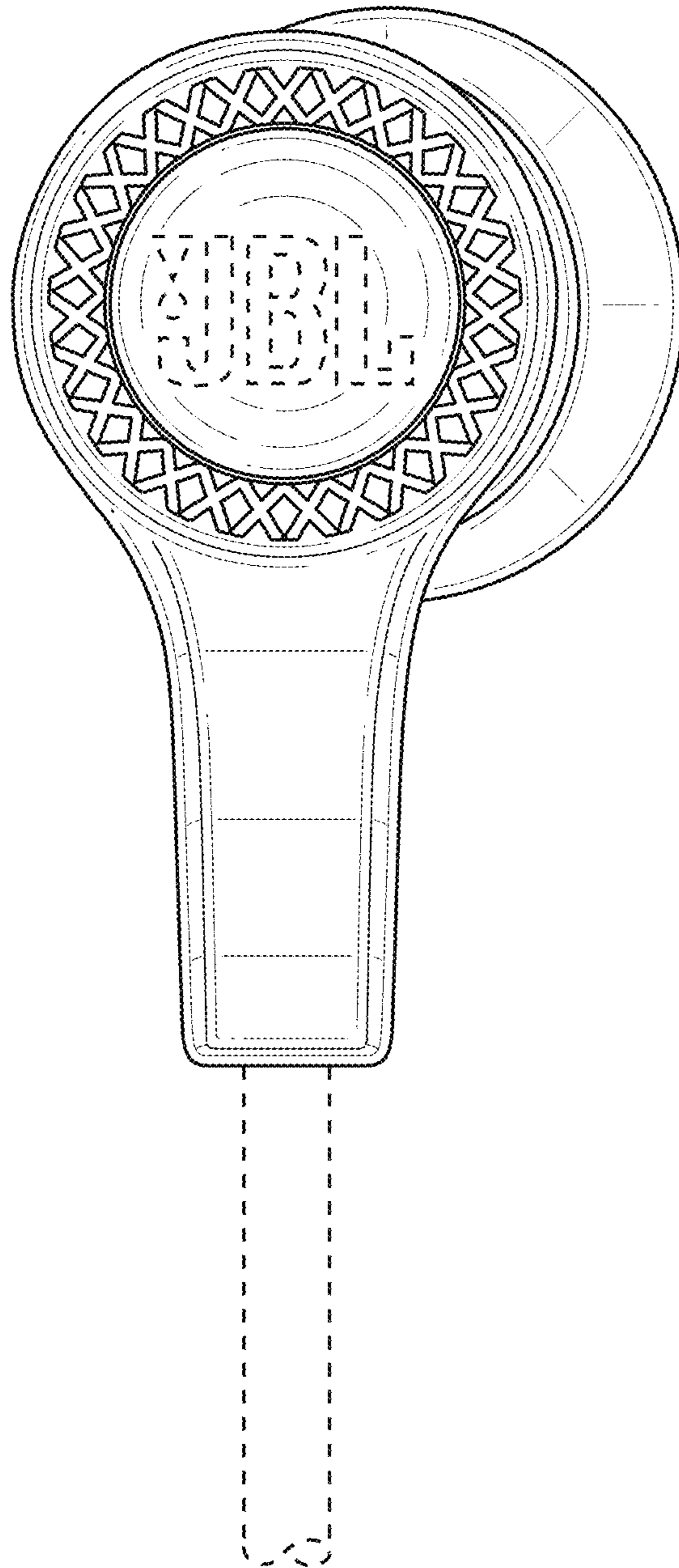


FIG. 11

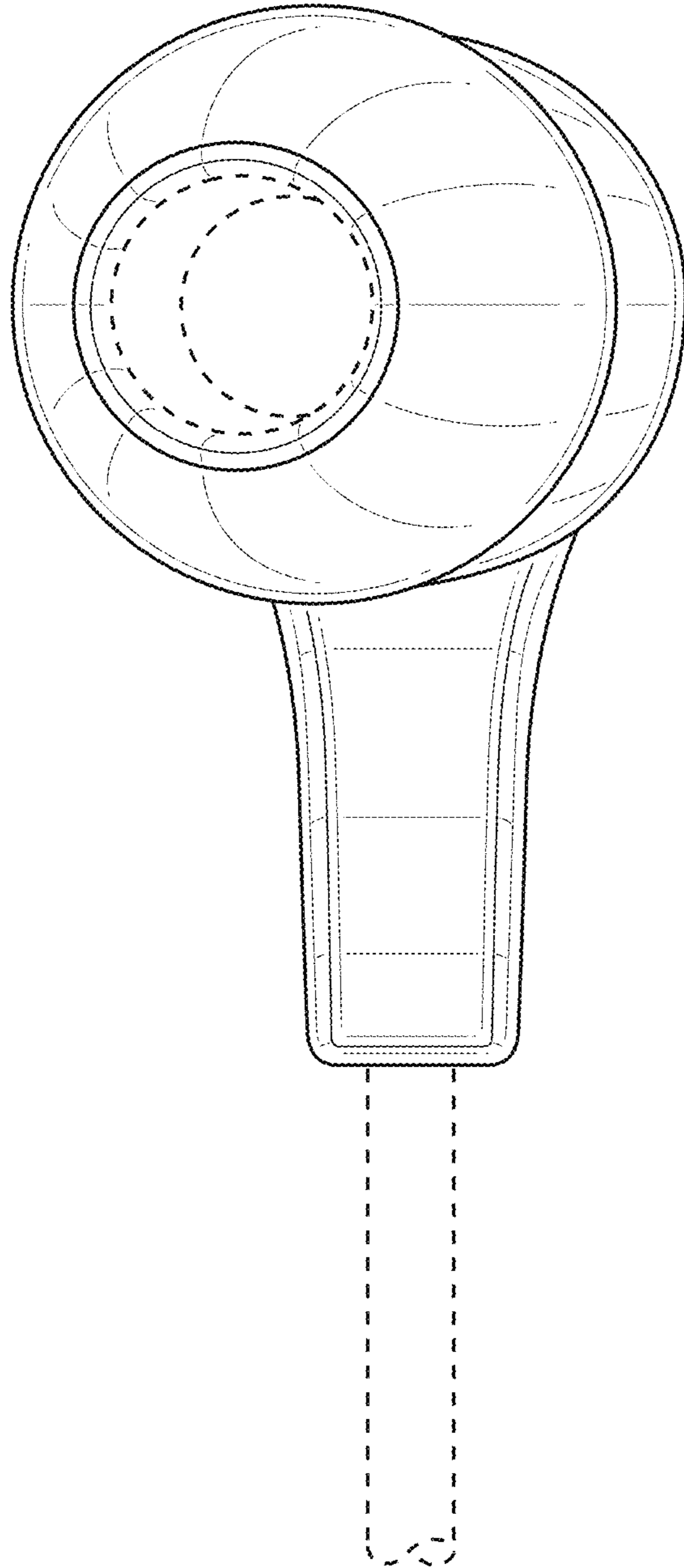


FIG. 12

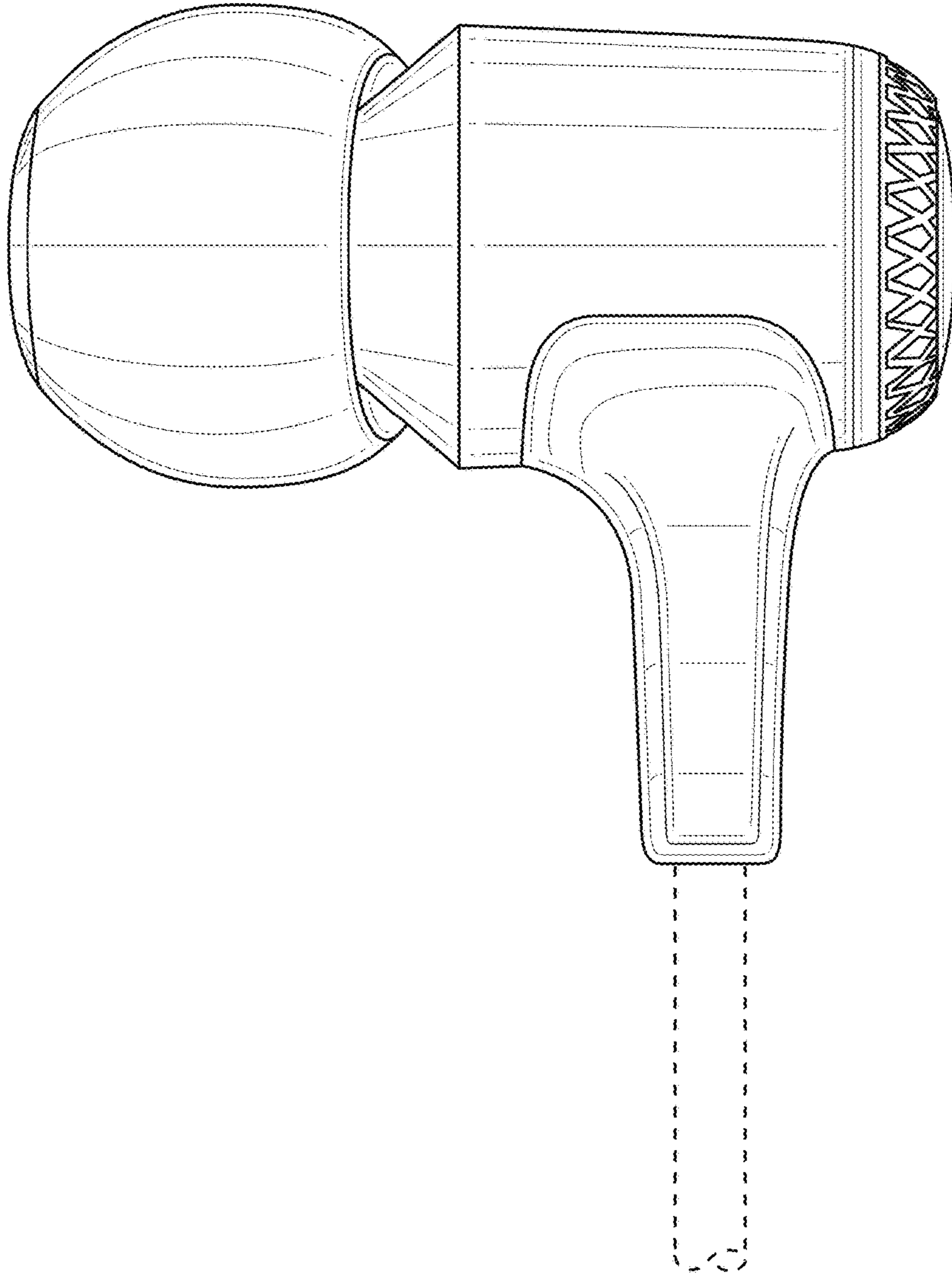


FIG. 13

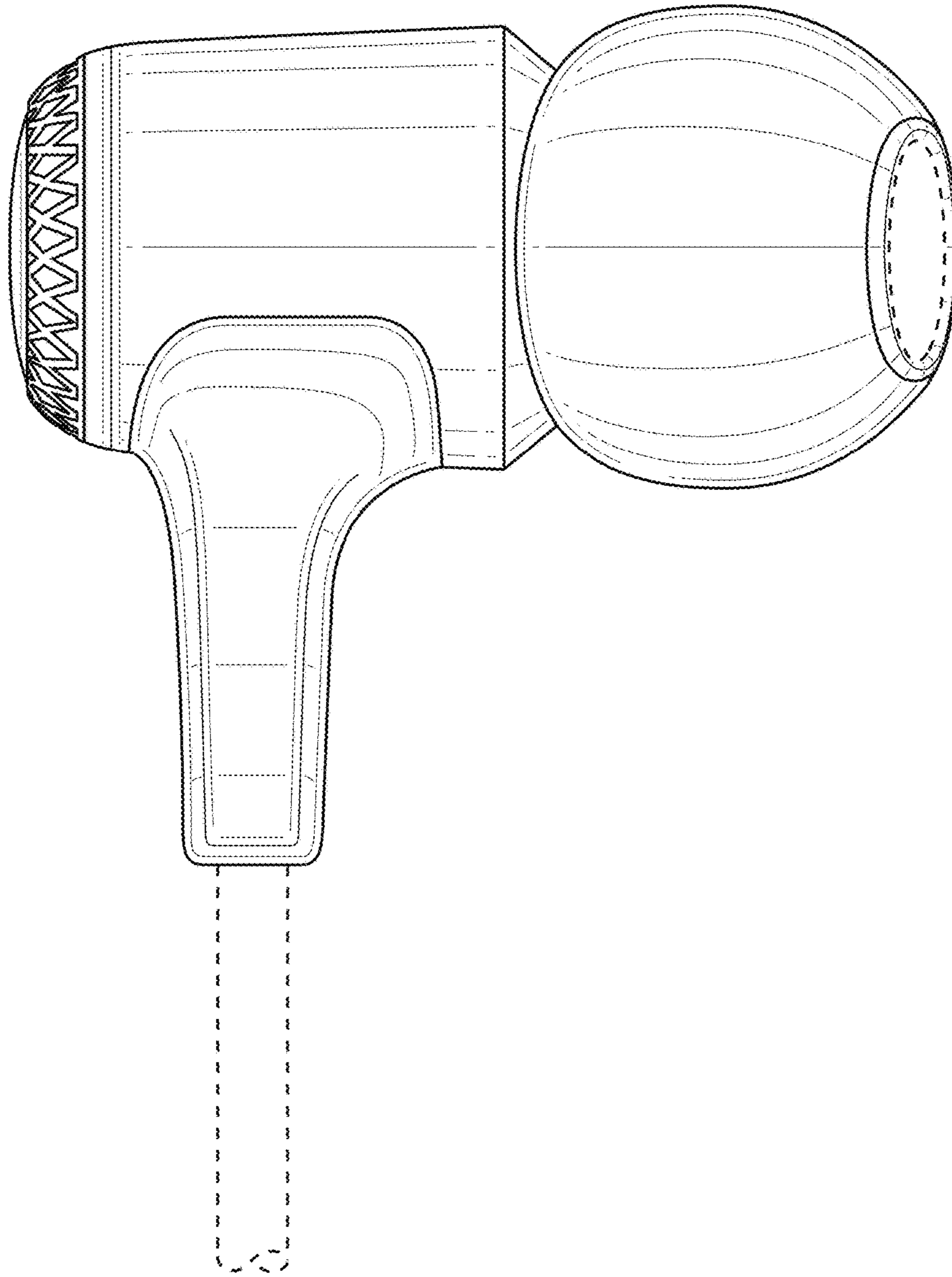


FIG. 14

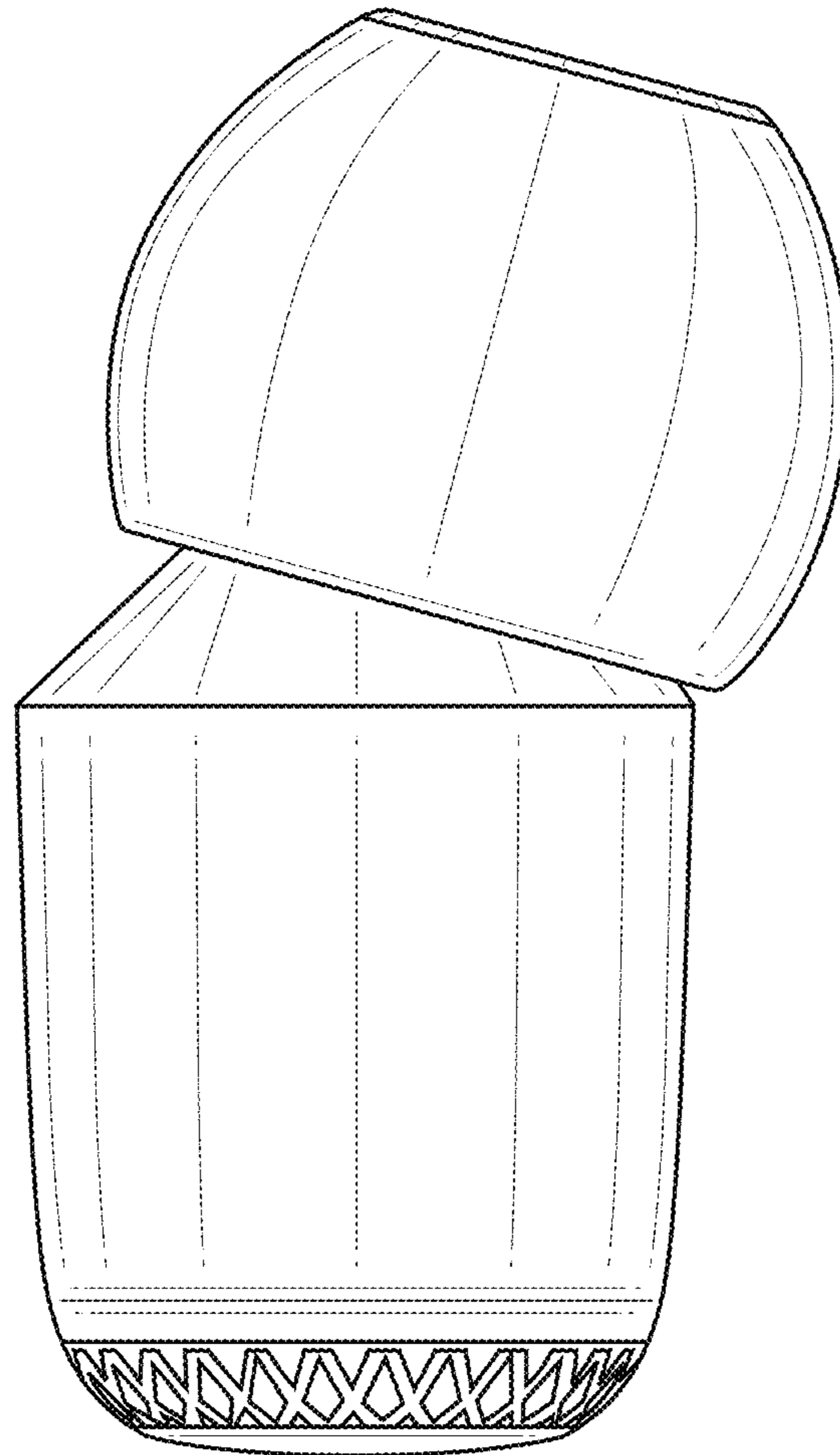


FIG. 15

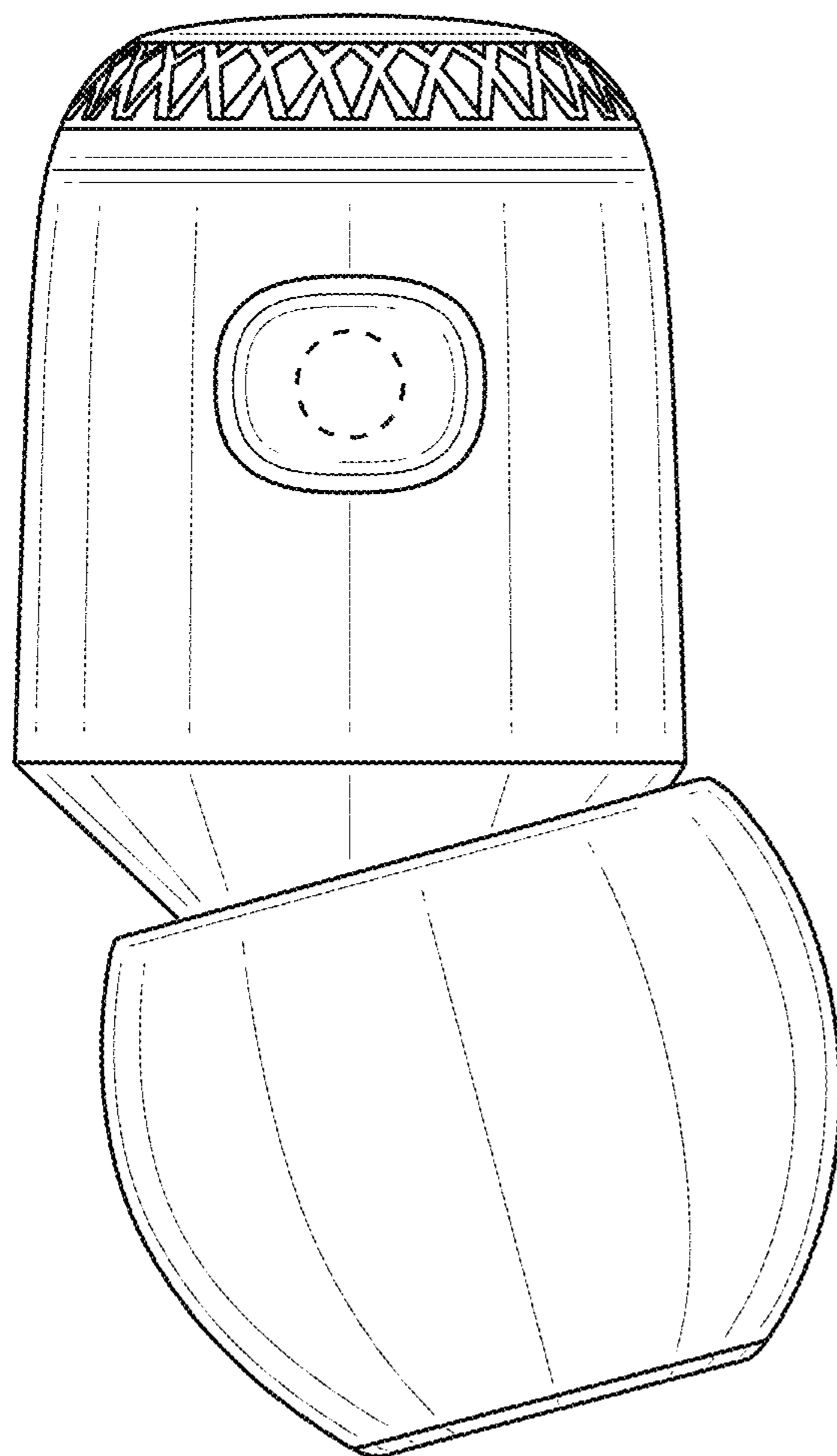


FIG. 16